# **MOSFET** – Single N-Channel

150 V, 4.4 mΩ, 187 A

# NTBLS4D0N15MC

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### **Typical Applications**

- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

				,	
Symbol	Parameter		Value	Unit	
V <sub>DSS</sub>	Drain-to-Source Voltage			150	V
V <sub>GS</sub>	Gate-to-Source Voltag	е		±20	V
Ι <sub>D</sub>	Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	$T_C = 25^{\circ}C$	187	А
P <sub>D</sub>	Power Dissipation $R_{\theta JC}$ (Note 2)			316	W
Ι <sub>D</sub>	Continuous Drain Current R <sub>θJA</sub> (Notes 1, 2)	Steady State	T <sub>A</sub> = 25°C	19	A
P <sub>D</sub>	Power Dissipation $R_{\theta JA}$ (Notes 1, 2)			3.4	W
I <sub>DM</sub>	Pulsed Drain Current	T <sub>A</sub> = 25°C	C, t <sub>p</sub> = 10 μs	2255	А
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Range	Storage Te	emperature	–55 to 175	°C
۱ <sub>S</sub>	Source Current (Body Diode)			263	А
E <sub>AS</sub>	Single Pulse Drain-to-Source Avalanche Energy (I <sub>L</sub> = 81.5 A <sub>pk</sub> , L = 0.1 mH)			332	mJ
ΤL	Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)			260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 1 oz Cu pad.

2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



# **ON Semiconductor®**

#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
150 V	4.4 mΩ @ 10 V	187 A
	4.9 mΩ @ 8 V	



## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>		
NTBLS4D0N15MC	MO-299A (Pb-Free)	2000 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### THERMAL RESISTANCE RATINGS

Symbol	Parameter	Мах	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State (Note 2)	0.5	°C/W
R <sub>0JA</sub>	Junction-to-Ambient - Steady State (Note 2)	43	

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

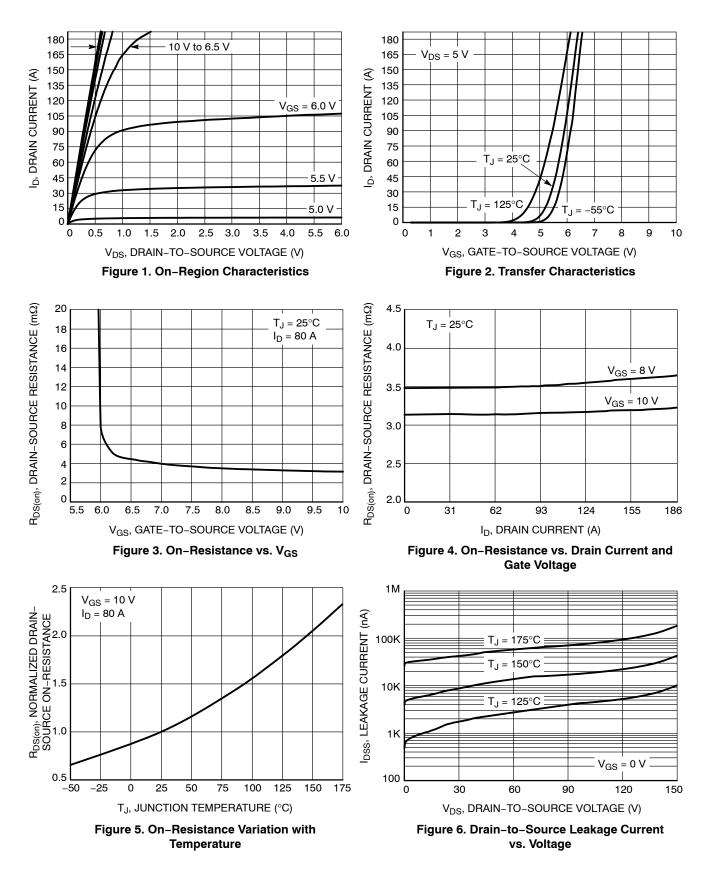
Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARACI	FERISTICS	-		-	-		-
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		150	-	-	V
$V_{(BR)DSS}/T_J$	Drain-to-Source Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$		-	30.23	-	mV/∘C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{GS} = 0 V, V_{DS} = 120 V$	$T_J = 25^{\circ}C$	-	-	1	μΑ
			T <sub>J</sub> = 125°C	-	-	10	μΑ
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS}$	s = ±20 V	-	-	±100	nA
ON CHARACTE	ERISTICS						
V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D$	= 584 μA	2.5	3.7	4.5	V
V <sub>GS(TH)</sub> / T <sub>J</sub>	Negative Threshold Temperature Coefficient	I <sub>D</sub> = 250 μA, re	f to 25°C	-	-10.12	-	mV/°C
R <sub>DS(on)</sub>	Drain-to-Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 80 A V <sub>GS</sub> = 8 V, I <sub>D</sub> = 53 A		-	3.1	4.4	mΩ
				-	3.5	4.9	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 80 A		-	174	-	S
R <sub>G</sub>	Gate-Resistance	T <sub>A</sub> = 25°C		-	1.3	-	Ω
CHARGES & C	APACITANCES	1					
C <sub>ISS</sub>	Input Capacitance	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 75 V		-	7490	-	pF
C <sub>OSS</sub>	Output Capacitance			-	2055	-	
C <sub>RSS</sub>	Reverse Transfer Capacitance			-	27.2	-	
Q <sub>G(TOT)</sub>	Total Gate Charge	$V_{GS} = 10 V, V_{E}$	<sub>OS</sub> = 75 V,	-	90.4	-	nC
Q <sub>G(TH)</sub>	Threshold Gate Charge	l <sub>D</sub> = 80 A		_	24.7	-	
$Q_{GS}$	Gate-to-Source Charge			-	40.2	-	
Q <sub>GD</sub>	Gate-to-Drain Charge			-	12.6	-	
V <sub>GP</sub>	Plateau Voltage			-	5.7	-	V
Q <sub>OSS</sub>	Output Charge	$V_{GS} = 0 V, V_{DS}$	s = 75 V	-	251	-	nC
WITCHING CH	HARACTERISTICS, V <sub>GS</sub> = 10 V (Note 3)						
t <sub>d(ON)</sub>	Turn-On Delay Time	$V_{GS} = 10 V, V_{C}$	<sub>S=</sub> 75 V,	-	47	-	ns
t <sub>r</sub>	Rise Time	$I_D = 80 \text{ A}, \text{ R}_G = 6 \Omega$		-	115	-	
t <sub>d(OFF)</sub>	Turn-Off Delay Time		-	58	-		
t <sub>f</sub>	Fall Time		-	11	-		
DRAIN-SOURC	CE DIODE CHARACTERISTICS						
V <sub>SD</sub>	Forward Diode Voltage	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$	-	0.86	1.2	V
		I <sub>S</sub> = 80 A	T <sub>J</sub> = 125°C	-	0.75	-	

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted) (continued)

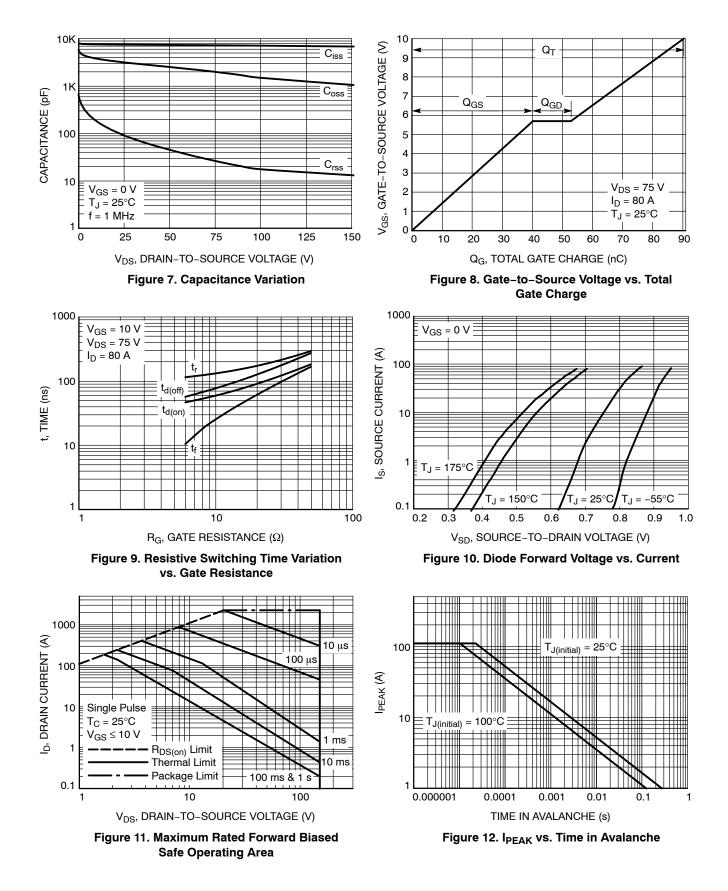
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
t <sub>RR</sub>	Reverse Recovery Time	$V_{GS} = 0 V, dI_S/dt = 100 A/\mu s,$	_	84	-	ns
t <sub>a</sub>	Charge Time	I <sub>S</sub> = 80 A	-	55	-	
t <sub>b</sub>	Discharge Time		-	29	-	
Q <sub>RR</sub>	Reverse Recovery Charge		-	180	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.3. Switching characteristics are independent of operating junction temperatures

### **TYPICAL CHARACTERISTICS**



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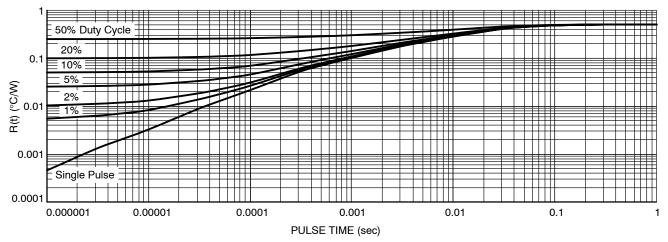
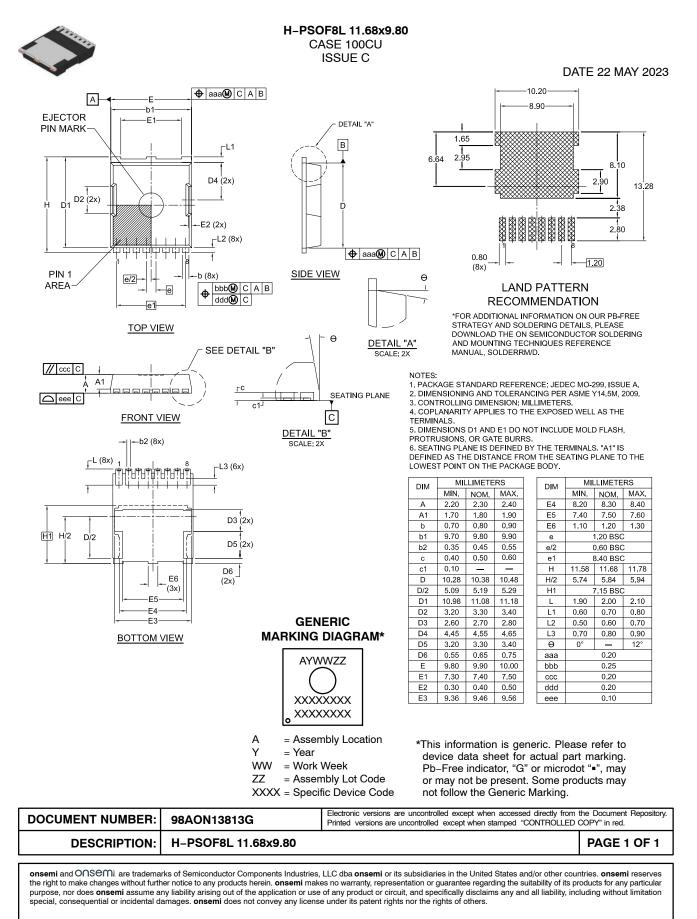


Figure 13. Thermal Characteristics (Junction-to-Ambient)

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